

SiPMs in the liquid xenon gammaray detector for MEG II experiment







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Instrumentation in Future Liquid Noble Gas

- - by MEG experiment



- Background
 - Accidental background is our dominant source
- Sensitivity improvement
 - High intensity muon beam (large statistics)
 - Good detector resolution (low background)

Paul Scherrer Institute in Switzerland



590 MeV 2.4mA proton ring cyclotron



MEG II Experiment

Gamma-ray (y)

900 I Liquid Xenon **y Detector Better uniformity** w/ VUV-sensitive **12x12mm² 4092 MPPC** + 668 PMTs

Downstream

Positron

(e⁺)

Radiative Decay Counter **Further reduction**

of radiative BG

x2 resolution everywhere

Target sensitivity : 6×10⁻¹⁴ (90%C.L.)

COBRA SC Magnet

Muon (µ⁺)

Upstream

muon rate: 4x10⁷/s

Pixelated Positron Timing Counter 30ps resolution w/ multiple hits

Cylindrical Drift Chamber

Single volume small stereo cells more hits





e detector

LXe inside



MEG II proposal 2013 *i*de Detector R&D 2012-2015 Construction in 2015-2020 Commissioning and physics run 2021-



WaveDREAM waveform digitizer



MEG II data





Data & fit results

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- Maximum likelihood analysis to estimate Nsig
 - Signal and RMD PDFs from resolution measurements
 - Accidental BKG PDFs from sidebands (fully datadriven)
- No excess was observed with the first 7week data in 2021
- Set the upper limit @90%CL $\mathcal{B}(\mu \to e\gamma) < 7.5 \times 10^{-13}$ with sensitivity of 8.8×10^{-13}
- Combined result of MEG and MEG II 2021 provides the most stringent limit on the Branching ratio

 $\mathscr{B}(\mu \to e\gamma) < 3.1 \times 10^{-13}$

(f) Relative signal likelihood

$$\begin{aligned} R_{\rm sig} &= \log_{10} \left(\frac{S(x_i)}{f_{\rm RMD} R(x_i) + f_{\rm ACC} A(x_i)} \right) \\ f_{\rm RMD} &= 0.02, \, f_{\rm ACC} = 0.98 \end{aligned}$$





MEG II prospects

- MEG II experiment will accumulate the physics data several years at least until 2027
 - The PSI accelerator beam line has an upgrade plan (HiMB) to have the beam intensity of 10¹⁰ µ/s starting from 2027
 - The PiE5 beamline will be shared with Mu3e experiment
- The sensitivity of the MEG II experiment will reach $Br(\mu \rightarrow e\gamma)$ ~(5–6)×10⁻¹⁴ @90%C.L. by then
- In parallel, 2022 analysis is ongoing. The results will be published this year which will have better sensitivity than MEG



MEG II Liquid Xenon Detector







Position, timing, energy measurements of 52.8 MeV γ •

- C-shape to fit the cylindrical shape of the superconducting magnets
- Thin entrance window for γ (honeycomb structure) : 0.075X₀ •
 - $66 \text{ cm} (\text{horizontal}) \times 140 \text{ cm} (\text{arc})$

Detector medium : 900 I LXe \bullet

- Homogeneous
- Heavy (3 g/cm³) : high γ efficiency
- High light yield (only scintillation light readout) ۲
- decay time : $45ns(\gamma)$
- Depth 38.5cm (~13X₀)

w-axis

- Scintillation readout : 4092 MPPC • $(15 \times 15 \text{ mm}^2) + 668 \text{ PMTs} (51 \text{ mm}\phi)$
 - immersed in LXe (0.029X₀ from MPPC)
 - Sensitive to VUV-light (175nm)
 - Operational at 165K
 - All the waveforms are recorded by WaveDREAM (DRS4) •



New SiPM development

- LXe detector widely used for many applications
 - LFV experiment, dark matter search, double beta decay search, medical applications
- 2" diameter PMT (Hamamatsu, R9869)
 - working in LXe, developed for MEG in collaboration with Hamamatsu. $QE \sim 15\%$
- SiPM is a good candidate to replace PMT
 - 1p.e. peak resolution, insensitive to magnetic field, thin, lower bias voltage etc.
- MPPC for MEG II (Hamamatsu, S10943-4372)
 - MPPC is one of SiPMs produced by HPK
 - Four 6x6 mm² chips, ceramic package, 50µm • pixel pitch, VUV-sensitive, quartz window in front of SiPM, metal quench resistor



Large Area SiPM

- Large area SiPM in general has ullet
 - large capacitance, long signal tail •
 - large dark rate (no problem at LXe T) •
- Our solution (to make a single ch. 12x12mm² MPPC)
 - Segmented into 4 chips, which are connected in series for signal readout line, in parallel for voltage supply line
 - Avoid large capacitance, manageable signal tail is realized • (<50ns)
 - Common bias voltage (~65V)
 - Dark noise suppressed at low temperature •
 - Single photoelectron peak can be resolved



- Vover $\sim 7V$
- Gain: 8x10⁵, PDE>~15%, Signal decay time: 30ns



MPPCs plugged on assembly PCB

- Series connection for four chips on PCB •
- 22 MPPCs on a PCB, two PCB on a row, 93 • lines result in 4092 MPPCs
- MPPC signal transmitted over long cable (11-13.4m) w/o amplifier
- High density PCB-based feedthrough
 - PCB with coaxial-like signal line, 50Ω • impedance, high noise immunity
 - High density 72ch x 6 PCB x 10 flanges •
- Waveform digitizer
 - Fully integrated DAQ board including bias supply for SiPM, waveform digitizer, FPGAbased trigger (WaveDREAM)



LXe detector commissioning



- 2017 Detector construction completed \bullet
 - sensor calibration, muon beam run with reduced number of readout sensors •
- 2021 Full electronics ready, detector performance evaluation work started

LXe detector event reconstruction & calibration

5-D reconstruction

- Energy : sum of MPPC/PMT charges
- Position (3D) : MPPC/PMT charge distribution
- Time : average MPPC/PMT time
- Calibration •
 - LED for gain, ²⁴¹Am for PDE, QE •
 - 17.6 MeV γ from ⁷Li(p, γ)⁸Be reaction
 - 55, 83 MeV γ from π -p \rightarrow π ⁰n reaction











Detector monitoring

•	PMT Gain	gain	850
	 Absolute PMT gain is calculated with LED 		800
	 Constantly gain is decreased under muon beam 		750
	 Twice HVs were adjusted during run 2022 		700
•	I Xe liaht vield		650 0
	 Monitored by α events by PMTs Assumption of constant PMT QE During the run, the gaseous purification is always on with getter At the beginning, liquid purification with molecular sieves also performed 		0.16 0.14 0.12 0.1 0.08

0.06



- Measured gain and ECF of MPPCs as a function of serial numbers •
- Production lot dependences observed

charge increase by cross-talk and after-pulse from the poisson mean

MPPC calibration

average ECF

MPPC monitoring

Gain and ECF are sufficiently stable

- MPPC PDE monitored by α peaks. •
- not stopped

MPPC PDE decrease

PDE decrease was observed when we started using muon beam, and was

PDE decrease mechanism

Particle	Dose/Fluence	
Gamma-ray	$1 \times 10^{-4} \text{Gy}$	_<<
Neutron	3×10^6 cm ⁻² (1 MeV equivalent)	<<
VUV photon	$6 \times 10^{10} \text{ mm}^{-2}$	

240Gy 10⁹ cm⁻²

Possible cause

Surface damage by VUV-light

- Electron-hole pair generated in SiO2 by **VUV** light
- Holes are trapped at interface SiO2-Si
- Accumulated positive charge will reduce electric field near Si surface, reducing collection efficiency of charge carrier
- Similar phenomena are known for UV photo diode
 - Degradation happens only with much larger amount of light at room temperature
 - Degradation seems accelerated at low temp.

We haven't reproduced the PDE decrease in lab. measurement yet

Solution for PDE decrease

- Joule annealing method
 - Supply ~1.7W per MPPC using high current and LED light
- Annealing power supply
 - 30 outputs. Each connected to 8ch \rightarrow 240ch/set
 - 4092 MPPCs \rightarrow 17 sets of annealing repeated
- 30 hours annealing / set + cabling work ~ 3 days / set \rightarrow 1.5 month annealing

Temperature limit • MPPC: 100°C • PCB: 120°C • CFRP: 45°C

• Glue: 65°C

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 v_{γ} [cm]

Summary

- with 2021 data were presented last year.
- photo sensors has been started since 2021.
- The sensor calibration and monitoring methods are established, and the detector performances are evaluated for the physics data analysis.
- recover the PDE has been established by Joule annealing method.

 The MEG II experiment looks for new physics beyond the standard model by studying the $\mu^+ \rightarrow e^+\gamma$ decay with the target sensitivity of 6×10^{-14} before 2027. The MEG II experiment started physics data taking in 2021, and the first results

• The 900 I liquid xenon detector is used for the γ detection, and 4092 VUVsensitive MPPCs are newly installed in the detector. The full readout of all the

The reason of the PDE decrease has to be understood, but the remedy to

Charged Lepton Flavor Violation

From Wikipedia

Searches for Charged-Lepton Flavor Violation in Experiments using Intense Muon Beams

High intensity muon beam (DC)

Paul Scherrer Institute in Switzerland

590 MeV 2.4mA proton ring cyclotron

Proton accelerator

50 MHz RF time structure $<< \mu$ lifetime $\sim 2\mu$ s No time structure in muon decay (continuous)

World most intense DC muon beam > $10^8 \mu/s$ Surface muon beam ~ 29 MeV/c

Signal Background e $E_{\gamma}, E_e \sim 52.8 \ MeV$ $\Theta_{e\gamma} = 180^\circ, T_{\gamma} = T_e$

- High statistics: High intensity muon beam •
- Low background:

 - Good detector resolutions

$\mu \rightarrow e\gamma$ signal and background

 $N_{acc} \propto (R_{\mu})^2 \times (\Delta E_{\gamma})^2 \times \Delta E_e \times (\Delta \Theta_{e\gamma})^2 \times \Delta t_{e\gamma} \times T$

Lower instantaneous muon beam rate (DC muon beam, not pulse beam)

PMT gain calculation

Photon statistics relations •

$$\sigma_Q^2 = G \cdot e \cdot \overline{Q} + \sigma_0^2$$

- σ_Q^2 : spread of integrated charge distribution
- G: gain
- e: elementary charge
- \bar{Q} : mean of integrated charge

×10⁻³ Variance [10¹⁸e²] 0.0 0.5 0.4 0.3 0.2 Fit, Gain=(8.07 \pm 0.14) $\times 10^5$ 0.1 0.1 0.2 0.3 Charge [10⁹e]

Radiation hardness

- Radiation produces defect in silicon bulk or Si/ SiO₂ interface
 - Dark count rate, leakage current, PDE, ...
- Fast neutron
 - $>10^8$ n/cm² Increase of dark count rate
 - $>10^{10}$ n/cm² Loss of single p.e. detection capability
 - <1 n/s/cm²(>0.1MeV) ~ <1.6x10⁸ n/cm² for full 5-years operation in π E5 area in PSI
 - $\sim 3.5 \text{ n/s/cm}^2 \sim 10^7 \text{ n/cm}^2$ for one week CEX run per year for 5-years
- γ-ray
 - 200Gy Increase of leak current
 - MC: 0.58Gy with $10^8 \,\mu/s$ for 5-years for MEG
- Radiation damage might not be an issue for MEG.

- Temperature dependent template (slope from waveform digitizer) ullet
- Readout electronics voltage offset template •
- High frequency noise template (clock signal in waveform • digitizer)
- The first cell dependent noise template •

Noise reduction

MPPC alignment

MPPC position alignment

- Direct optical alignment at room temperature
- Collimated γ beam to the detector with LXe
 - To take into account thermal expansion of MPPC supports (CFRP, PCB)
- Combined result
 - position uncertainty 0.6mm in z and 0.75mrad in $\boldsymbol{\varphi}$

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